

CMOS DUAL SyncFIFO™ DUAL 256 x 18 DUAL 512 x 18 DUAL 1,024 x 18 DUAL 4,096 x 18

IDT72805LB IDT72815LB IDT72825LB IDT72845LB

LEAD FINISH (SnPb) ARE IN EOL PROCESS - LAST TIME BUY EXPIRES JUNE 15, 2018

FEATURES:

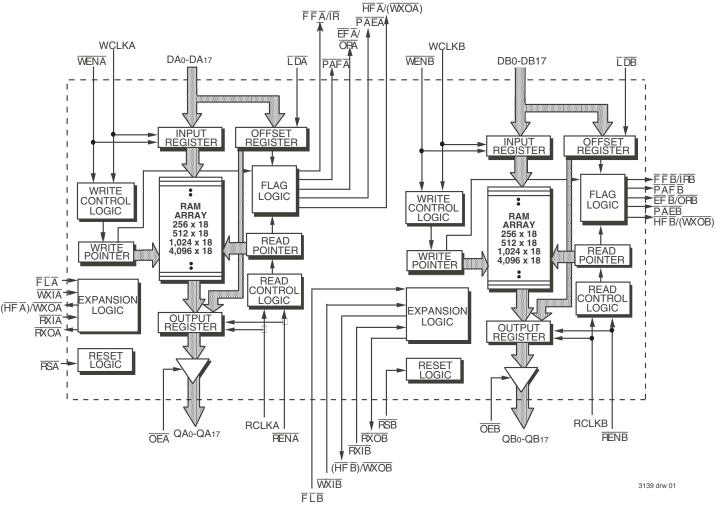
- The IDT72805LB is equivalent to two IDT72205LB 256 x 18 FIFOs
- The IDT72815LB is equivalent to two IDT72215LB 512 x 18 FIFOs
- The IDT72825LB is equivalent to two IDT72225LB 1,024 x 18 FIFOs
- The IDT72845LB is equivalent to two IDT72245LB 4,096 x 18 FIFOs
- Offers optimal combination of large capacity (8K), high speed, design flexibility, and small footprint
- Ideal for the following applications:
 - Network switching
 - Two level prioritization of parallel data
 - Bidirectional data transfer
 - Bus-matching between 18-bit and 36-bit data paths
 - Width expansion to 36-bit per package
 - Depth expansion to 8,192 words per package
- 10ns read/write cycle time, 6.5ns access time
- IDT Standard or First Word Fall Through timing
- Single or double register-buffered Empty and Full Flags

FUNCTIONAL BLOCK DIAGRAM

- Easily expandable in depth and width
- · Asynchronous or coincident Read and Write clocks
- Asynchronous or synchronous programmable Almost-Empty and Almost-Full flags with default settings
- Half-Full flag capability
- Output Enable puts output data bus in high-impedance state
- · High-performance submicron CMOS technology
- Available in the 128-pin Thin Quad Flatpack (TQFP). Also available for the IDT72805LB/72815LB/72825LB, in the 121-lead, 16 x 16 mm plastic Ball Grid Array (PBGA)
- Industrial temperature range (-40°C to +85°C) is available
- · Green parts available, see ordering information

DESCRIPTION:

The IDT72805LB/72815LB/72825LB/72845LB are dual 18-bit-wide synchronous (clocked) First-in, First-out (FIFO) memories. One dual IDT72805LB/



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DESCRIPTION (Continued)

72815LB/72825LB/72845LB device is functionally equivalent to two IDT72205LB/72215LB/7225LB/72245LB FIFOs in a single package with all associated control, data, and flag lines assigned to independent pins. These devices are very high-speed, low-power First-In, First-Out (FIFO) memories with clocked read and write controls. These FIFOs are applicable for a wide variety of data buffering needs, such as optical disk controllers, Local Area Networks (LANs), and interprocessor communication.

Each of the two FIFOs contained in these devices has an 18-bit input and output port. Each input port is controlled by a free-running clock (WCLK), and an input enable pin (WEN). Data is read into the synchronous FIFO on every clock when WEN is asserted. The output port of each FIFO bank is controlled by another clock pin (RCLK) and another enable pin (REN). The Read Clock can be tied to the Write Clock for single clock operation or the two clocks can run asynchronous of one another for dual-clock operation. An Output Enable pin (\overline{OE}) is provided on the read port of each FIFO for three-state control of the output.

The synchronous FIFOs have two fixed flags, Empty Flag/Output Ready (EF/OR) and Full Flag/Input Ready (FF/IR), and two programmable flags,

Almost-Empty (PAE) and Almost-Full (PAF). The offset loading of the programmable flags is controlled by a simple state machine, and is initiated by asserting the Load pin (LD). A Half-Full flag (HF) is available for each FIFO that is implemented as a single device configuration.

There are two possible timing modes of operation with these devices: IDT Standard mode and First Word Fall Through (FWFT) mode.

In IDT Standard Mode, the first word written to an empty FIFO will not appear on the data output lines unless a specific read operation is performed. A read operation, which consists of activating REN and enabling a rising RCLK edge, will shift the word from internal memory to the data output lines.

In FWFT mode, the first word written to an empty FIFO is clocked directly to the data output lines after three transitions of the RCLK signal. A REN does not have to be asserted for accessing the first word.

These devices are depth expandable using a daisy-chain technique or First Word Fall Through (FWFT) mode. The \overline{XI} and \overline{XO} pins are used to expand the FIFOs. In depth expansion configuration, \overline{FL} is grounded on the first device and set to HIGH for all other devices in the Daisy Chain.

The IDT72805LB/72815LB/72825LB/72845LB are fabricated using high-speed submicron CMOS technology.

•											
А	WCLKA	DA3	DA1	DA0	DB13	DB16	RCLKB	LDB	RSB	QB17	QB16
В	PAFA	DA4	WENA	DA2	DB12	DB15	RENB	OEB	EFB	QB15	QB14
с	FFA	RXIA		DA5	DB14	DB11	GND	DB17	GND	QB13	QB11
D	RXOA	QA0	QA2	FLA	DB8	DB10	DB7	VCC	QB12	QB10	QB8
E	QA1	QA4	QA3	WXOA/ HFA	PAEA	DB9	DB6	VCC	VCC	QB9	QB7
F	QA5	QA6	GND	VCC	GND	GND	GND	VCC	GND	QB6	QB5
G	QA7	QA9	vcc	VCC	DA6	DA9	PAEB	WXOB/ HFB	QB3	QB4	QB1
н	QA8	QA10	QA12	VCC	DA7	DA10	DA8	FLB	QB2	QB0	RXOB
J	QA11	QA13	GND	DA17	GND	DA11	DA14	DB5	WXIB	RXIB	FFB
к	QA14	QA15	EFA	ŌĒĀ	RENA	DA15	DA12	DB2	WENB	DB4	PAFB
L	QA16	QA17	RSA	LDA	RCKLA	DA16	DA13	DB0	DB1	DB3	WCLKB
Ļ	<u> </u>										
	1	2	3	4	5	6	7	8	9	10	11 3139 drw 02
	PBGA (BG121, order code: BG)										0100 014 02

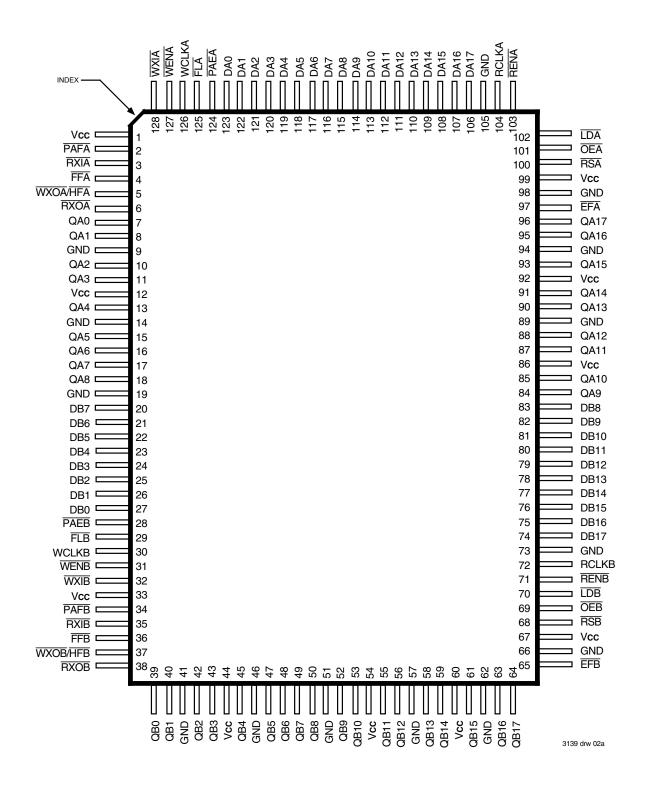
PIN CONFIGURATIONS

PBGA (BG121, order code: BG) TOP VIEW

NOTE:

1. The PBGA is only available for the IDT72805LB/72815LB/72825LB in the 15 or 25 ns speed grade.

PIN CONFIGURATIONS (Continued)



TQFP (PK128, order code: PF) TOP VIEW

PIN DESCRIPTION

Symbol	Name	I/O	Description
DA0-DA17 DB0-DB17	Data Inputs	Ι	Data inputs for an 18-bit bus.
RSA RSB	Reset	I	When $\overline{\text{RS}}$ is set LOW, internal read and write pointers are set to the first location of the RAM array, $\overline{\text{FF}}$ and $\overline{\text{PAF}}$ go HIGH, and $\overline{\text{PAE}}$ and $\overline{\text{EF}}$ go LOW. A reset is required before an initial WRITE after power-up.
WCLKA WCLKB	Write Clock	I	When $\overline{\text{WEN}}$ is LOW, data is written into the FIFO on a LOW-to-HIGH transition of WCLK, if the FIFO is not full.
WENA WENB	Write Enable	I	When $\overline{\text{WEN}}$ is LOW, data is written into the FIFO on every LOW-to-HIGH transition of WCLK. When $\overline{\text{WEN}}$ is HIGH, the FIFO holds the previous data. Data will not be written into the FIFO if the $\overline{\text{FF}}$ is LOW.
RCLKA RCLKB	Read Clock	I	When REN is LOW, data is read from the FIFO on a LOW-to-HIGH transition of RCLK, if the FIFO is not empty.
RENA RENB	Read Enable	I	When $\overline{\text{REN}}$ is LOW, data is read from the FIFO on every LOW-to-HIGH transition of RCLK. When $\overline{\text{REN}}$ is HIGH, the output register holds the previous data. Data will not be read from the FIFO if the $\overline{\text{EF}}$ is LOW.
OEA OEB	Output Enable	I	When \overline{OE} is LOW, the data output bus is active. If \overline{OE} is HIGH, the output data bus will be in a high-impedance state.
LDA LDB	Load	I	When $\overline{\text{LD}}$ is LOW, data on the inputs D0–D11 is written to the offset and depth registers on the LOW-to-HIGH transition of the WCLK, when $\overline{\text{WEN}}$ is LOW. When $\overline{\text{LD}}$ is LOW, data on the outputs Q0–Q11 is read from the offset and depth registers on the LOW-to-HIGH transition of the RCLK, when $\overline{\text{REN}}$ is LOW.
FLA FLB	First Load	I	In the single device or width expansion configuration, FL together with WXI and RXI determine if the mode is IDT Standard mode or First Word Fall Through (FWFT) mode, as well as whether the PAE/PAF flags are synchronous or asynchronous. (See Table I.) In the Daisy Chain Depth Expansion configuration, FL is grounded on the first device (first load device) and set to HIGH for all other devices in the Daisy Chain.
WXIA WXIB	Write Expansion Input	-	In the single device or width expansion configuration, WXI together with FL and RXI determine if the mode is IDT Standard mode or FWFT mode, as well as whether the PAE/PAF flags are synchronous or asynchronous. (See Table 1.) In the Daisy Chain Depth Expansion configuration, WXI is connected to WXO (Write Expansion Out) of the previous device.
RXIA RXIB	Read Expansion Input	Ι	In the single device or width expansion configuration, \overline{RXI} together with \overline{FL} and \overline{WXI} , determine if the mode is IDT Standard mode or FWFT mode, as well as whether the $\overline{PAE}/\overline{PAF}$ flags are synchronous or asynchronous. (See Table 1.) In the Daisy Chain Depth Expansion configuration, \overline{RXI} is connected to \overline{RXO} (Read Expansion Out) of the previous device.
FFA/IRA FFB/IRB	Full Flag/ Input Ready	0	In the IDT Standard mode, the \overline{FF} function is selected \overline{FF} indicates whether or not the FIFO memory is full. In the FWFT mode, the IR function is selected. IR indicates whether or not there is space available for writing to the FIFO memory.
EFA/ORA EFB/ORB	Empty Flag/ Output Ready	0	In the IDT Standard mode, the $\overline{\text{EF}}$ function is selected. $\overline{\text{EF}}$ indicates whether or not the FIFO memory is empty. In FWFT mode, the $\overline{\text{OR}}$ function is selected. $\overline{\text{OR}}$ indicates whether or not there is valid data available at the outputs.
PAEA PAEB	Programmable Almost-Empty flag	0	When PAE is LOW, the FIFO is almost-empty based on the offset programmed into the FIFO. The default offset at reset is 31 from empty for IDT72805LB, 63 from empty for IDT72815LB, and 127 from empty for IDT72825LB/72845LB.
PAFA PAFB	Programmable Almost-Fullflag	0	When $\overline{\text{PAF}}$ is LOW, the FIFO is almost-full based on the offset programmed into the FIFO. The default offset at reset is 31 from full for IDT72805LB, 63 from full for IDT72815LB, and 127 from full for IDT72825LB/72845LB.
WXOA/HFA WXOB/HFB	Write Expansion Out/Half-Full Flag	0	In the single device or width expansion configuration, the device is more than half full when \overline{HF} is LOW. In the depth expansion configuration, a pulse is sent from \overline{WXO} to \overline{WXI} of the next device when the last location in the FIFO is written.
RXOA RXOB	Read Expansion Out	0	In the depth expansion configuration, a pulse is sent from \overline{RXO} to \overline{RXI} of the next device when the last location in the FIFO is read.
QA0-QA17 QB0-QB17	Data Outputs	0	Data outputs for an 18-bit bus.
Vcc	Power		+5V power supply pins.
GND	Ground		Ground pins.

ABSOLUTE MAXIMUM RATINGS

Symbol	Rating	Commercial	Unit
Vterm	Terminal Voltage with respect to GND	–0.5 to +7.0	V
Tstg	Storage Temperature	-55 to +125	°C
Ιουτ	DC Output Current	-50 to +50	mA

NOTE:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS

Symbol	Parameter	Min.	Тур.	Max.	Unit
Vcc	Supply Voltage (Com'l/Ind'l)	4.5	5.0	5.5	V
GND	Supply Voltage (Com'l/Ind'l)	0	0	0	V
Vih	Input High Voltage (Com'l/Ind'l)	2.0	_	—	V
VIL ⁽¹⁾	Input Low Voltage (Com'l/Ind'l)			0.8	V
TA	TA Operating Temperature Commercial			70	°C
TA	Operating Temperature Industrial	-40	_	85	°C

NOTE:

1. 1.5V undershoots are allowed for 10ns once per cycle.

DC ELECTRICAL CHARACTERISTICS

(Commercial: Vcc = 5V \pm 10%, TA = 0°C to +70°C; Industrial: Vcc = 5V \pm 10%, TA = -40°C to +85°C)

			IDT72805LB IDT72815LB IDT72825LB IDT72845LB Com'I & Ind'I ⁽¹⁾ tcLK = 10, 15, 25 ns			
Symbol	Parameter	Min.	Тур.	Max.	Unit	
ILI ⁽²⁾	Input Leakage Current (any input)	-1	_	1	μA	
LO ⁽³⁾	Output Leakage Current	-10	_	10	μA	
Vон	Output Logic "1" Voltage, Іон = –2 mA	2.4	_	_	V	
Vol	Output Logic "0" Voltage, IoL = 8 mA	_	_	0.4	V	
ICC1 ^(4,5,6)	Active Power Supply Current		_	100	mA	
ICC2 ^(4,7)	StandbyCurrent	_	_	10	mA	

NOTES:

1. Industrial Temperature Range Product for the 15ns speed grade is available as a standard device.

2. Measurements with $0.4 \le V_{IN} \le V_{CC}$.

3. $\overline{OE} \ge V_{IH}, 0.4 \le V_{OUT} \le V_{CC}.$

4. Tested with outputs open (IOUT = 0).

4. RCLK and WCLK toggle at 20 MHZ and data inputs switch at 10 MHz.

5. For the IDT72805LB/72815LB/72825LB the typical lcc1 = 2[1.81 + 1.12*fs + 0.02*CL*fs] (in mA); for the IDT72845LB the typical lcc1 = 2[2.85 + 1.30*fs + 0.02*CL*fs] (in mA). These equations are valid under the following conditions:

Vcc = 5V, TA = 25°C, fs = WCLK frequency = RCLK frequency (in MHz, using TTL levels), data switching at fs/2, CL = capacitive load (in pF).

7. All Inputs = Vcc - 0.2V or GND + 0.2V, except RCLK and WCLK, which toggle at 20 MHz.

CAPACITANCE (TA = +25°C, f = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Max.	Unit
CIN ⁽²⁾	Input Capacitance	VIN = 0V	10	pF
Cout ^(1,2)	Output Capacitance	Vout = 0V	10	pF

NOTES:

1. With output deselected, ($\overline{OE} \ge V_{IH}$).

2. Characterized values, not currently tested.

AC ELECTRICAL CHARACTERISTICS

(Commercial: Vcc = 5V \pm 10%, TA = 0°C to +70°C; Industrial: Vcc = 5V \pm 10%, TA = -40°C + 85°C)

		Com	mercial	Com'l a	& Ind'I ⁽¹⁾	Commercial		
		IDT728 IDT728 IDT728	IDT72805LB10 IDT72815LB10 IDT72825LB10 IDT72845LB10		IDT72805LB15 IDT72815LB15 IDT72825LB15 IDT72845LB15		IDT72805LB25 IDT72815LB25 IDT72825LB25 IDT72845LB25	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
fs	Clock Cycle Frequency		100	-	66.7		40	MHz
tA	Data Access Time	2	6.5	2	10	3	15	ns
t CLK	Clock Cycle Time	10	_	15	_	25		ns
tськн	Clock HIGH Time	4.5	—	6	—	10		ns
tclkl	Clock LOW Time	4.5	_	6	_	10		ns
tos	Data Setup Time	3	—	4	—	6	-	ns
tон	Data Hold Time	0	—	1	—	1	—	ns
tens	EnableSetupTime	3	—	4	—	6	—	ns
tenh	Enable Hold Time	0	—	1	—	1	_	ns
trs	Reset Pulse Width ⁽²⁾	10	_	15	_	25	-	ns
trss	Reset Setup Time	8	_	10	_	15	-	ns
trsr	Reset Recovery Time	8	_	10	_	15	_	ns
t RSF	Reset to Flag and Output Time	_	15	_	15	_	25	ns
tolz	Output Enable to Output in Low-Z ⁽³⁾	0	_	0	_	0	_	ns
t OE	Output Enable to Output Valid	_	6	_	8		12	ns
tонz	Output Enable to Output in High-Z ⁽³⁾	1	6	1	8	1	12	ns
t WFF	Write Clock to Full Flag		6.5	_	10	_	15	ns
t REF	Read Clock to Empty Flag		6.5	_	10	_	15	ns
t PAFA	Clock to Asynchronous Programmable Almost-Full Flag	_	17	-	20	-	35	ns
T PAFS	Write Clock to Synchronous Programmable Almost-Full Flag	-	8	_	10	-	12	ns
İ PAEA	Clock to Asynchronous Programmable Almost-Empty Flag	—	17	_	20	_	35	ns
t PAES	Read Clock to Synchronous Programmable Almost-Empty Flag	_	8	-	10	_	12	ns
thf	Clock to Half-Full flag	—	17	_	20		35	ns
txo	Clock to Expansion Out		6.5	_	10	_	15	ns
txi	Expansion In Pulse Width	3	_	6.5	_	10	-	ns
txis	Expansion In Setup Time	3	_	5	_	10	_	ns
tskew1	Skew time between Read Clock & Write Clock for FF/IR and EF/OR	5	-	6	_	10	-	ns
tskew2 ⁽⁴⁾	Skew time between Read Clock & Write Clock for PAE and PAF	12	-	15	-	17	-	ns

NOTES:

1. Industrial Temperature Range Product for the 15ns speed grade is available as a standard device.

2. Pulse widths less than minimum values are not allowed.

3. Values guaranteed by design, not currently tested.

4. tskew2 applies to synchronous PAE and synchronous PAF only.

AC TEST CONDITIONS

1		
	Input Pulse Levels	GND to 3.0V
	•	
	Input Rise/Fall Times	3ns
		1 517
	Input Timing Reference Levels	1.5V
	Output Reference Levels	1.5V
	Output Load	See Figure 1

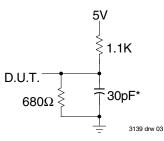


Figure 1. Output Load * Includes jig and scope capacitances.

FUNCTIONAL DESCRIPTION

TIMING MODES: IDT STANDARD vs FIRST WORD FALL THROUGH (FWFT) MODE

The IDT72805LB/72815LB/72825LB/72845LB support two different timing modes of operation. The selection of which mode will operate is determined during configuration at Reset (\overline{RS}). During a \overline{RS} operation, the First Load (\overline{FL}), Read Expansion Input (\overline{RXI}) and Write Expansion Input (\overline{WXI}) pins are used to select the timing mode per the truth table shown in Table 3. In IDT Standard Mode, the first word written to an empty FIFO will not appear on the data output lines unless a specific read operation is performed. A read operation, which consists of activating Read Enable (\overline{REN}) and enabling a rising Read Clock (RCLK) edge, will shift the word from internal memory to the data output lines. In FWFT mode, the first word written to an empty FIFO is clocked directly to the data output lines after three transitions of the RCLK signal. A \overline{REN} does not have to be asserted for accessing the first word.

Various signals, both input and output signals operate differently depending on which timing mode is in effect.

IDT STANDARD MODE

In this mode, the status flags, \overline{FF} , \overline{PAF} , \overline{HF} , \overline{PAE} and \overline{EF} operate in the manner outlined in Table 1. To write data into to the FIFO, Write Enable (WEN) must be LOW. Data presented to the DATA IN lines will be clocked into the FIFO on subsequent transitions of the Write Clock (WCLK). After the first write is performed, the Empty Flag (\overline{EF}) will go HIGH. Subsequent writes will continue to fill up the FIFO. The Programmable Almost-Empty flag (\overline{PAE}) will go HIGH after n + 1 words have been loaded into the FIFO, where n is the Empty offset value. The default setting for this value is stated in the footnote of Table 1. This parameter is also user programmable. See section on Programmable Flag Offset Loading.

If one continued to write data into the FIFO, and we assumed no read operations were taking place, the Half-Full flag (HF) would toggle to LOW once the 129th (IDT72805LB), 257th (IDT72815LB), 513th (IDT72825LB), and 2,049th (IDT72845LB) word respectively was written into the FIFO. Continuing to write data into the FIFO will cause the Programmable Almost-Full flag (PAF) to go LOW. Again, if no reads are performed, the PAF will go LOW after (256-m) writes for the IDT72805LB, (512-m) writes for the IDT72845LB. The offset "m" is the Full offset value. This parameter is also user programmable. See section on Programmable Flag Offset Loading. If there is no Full offset specified, the PAF will be LOW when the device is 31 away from completely full for IDT72805LB, 63 away from completely full for IDT72845LB.

When the FIFO is full, the Full Flag (\overline{FF}) will go LOW, inhibiting further write operations. If no reads are performed after a reset, \overline{FF} will go LOW after D writes to the FIFO. D = 256 writes for the IDT72805LB, 512 for the IDT72815LB, 1,024 for the IDT72825LB, and 4,096 for the IDT72845LB, respectively.

If the FIFO is full, the first read operation will cause FF to go HIGH. Subsequent read operations will cause PAF and the Half-Full flag (HF) to go HIGH at the conditions described in Table 1. If further read operations occur, without write operations, the Programmable Almost-Empty flag (PAE) will go LOW when there are n words in the FIFO, where n is the Empty offset value. If there is no Empty offset specified, the PAE will be LOW when the device is 31 away from completely empty for IDT72805LB, 63 away from completely empty for IDT72815LB, and 127 away from completely empty for IDT72825LB/72845LB. Continuing read operations will cause the FIFO to be empty. When the last word has been read from the FIFO, the EF will go LOW inhibiting further read operations. REN is ignored when the FIFO is empty.

FIRST WORD FALL THROUGH MODE (FWFT)

In this mode, the status flags, \overline{IR} , \overline{PAF} , \overline{HF} , PAE and \overline{OR} operate in the manner outlined in Table 2. To write data into to the FIFO, \overline{WEN} must be LOW. Data presented to the DATA IN lines will be clocked into the FIFO on subsequent transitions of WCLK. After the first write is performed, the Output Ready (\overline{OR}) flag will go LOW. Subsequent writes will continue to fill up the FIFO. PAE will go HIGH after n + 2 words have been loaded into the FIFO, where n is the Empty offset value. The default setting for this value is stated in the footnote of Table 2. This parameter is also user programmable. See section on Programmable Flag Offset Loading.

If one continued to write data into the FIFO, and we assumed no read operations were taking place, the $\overline{\text{HF}}$ would toggle to LOW once the 130th (72805LB), 258th (72815LB), 514th (72825LB), and 2,050th (72845LB) word respectively was written into the FIFO. Continuing to write data into the FIFO will cause the $\overline{\text{PAF}}$ to go LOW. Again, if no reads are performed, the $\overline{\text{PAF}}$ will go LOW after (257-m) writes for the IDT72805LB, (513-m) writes for the IDT72815LB, (1,025-m) writes for the IDT72825LB, and (4,097-m) writes for the IDT72845LB, where misthe Full offset value. The default setting for this value is stated in the footnote of Table 2.

When the FIFO is full, the Input Ready (\overline{IR}) flag will go HIGH, inhibiting further write operations. If no reads are performed after a reset, \overline{IR} will go HIGH after D writes to the FIFO. D = 257 writes for the IDT72805LB, 513 for the IDT72815LB, 1,025 for the IDT72825LB, and 4,097 for the IDT72845LB. Note that the additional word in FWFT mode is due to the capacity of the memory plus output register.

If the FIFO is full, the first read operation will cause the \overline{IR} flag to go LOW. Subsequent read operations will cause the \overline{PAF} and \overline{HF} to go HIGH at the conditions described in Table 2. If further read operations occur, without write operations, the \overline{PAE} will go LOW when there are n + 1 words in the FIFO, where n is the Empty offset value. If there is no Empty offset specified, the \overline{PAE} will be LOW when the device is 32 away from completely empty for IDT72805LB, 64 away from completely empty for IDT72815LB, and 128 away from completely empty for IDT72825LB/72845LB. Continuing read operations will cause the FIFO to be empty. When the last word has been read from the FIFO, \overline{OR} will go HIGH inhibiting further read operations. REN is ignored when the FIFO is empty.

PROGRAMMABLE FLAG LOADING

Full and Empty flag Offset values can be user programmable. The IDT72805LB/72815LB/72825LB/72845LB has internal registers for these offsets. Default settings are stated in the footnotes of Table 1 and Table 2. Offset values are loaded into the FIFO using the data input lines Do-D11. To load the offset registers, the Load (LD) pin and WEN pin must be held LOW. Data present on Do-D11 will be transferred in to the Empty Offset register on the first LOW-to-HIGH transition of WCLK. By continuing to hold the LD and WEN pin low, data present on Do-D11 will be transferred into the Full Offset register on the next transition of the WCLK. The third transition again writes to the Empty Offset register. Writing all offset registers does not have to occur at one time. One or two offset registers can be written and then by bringing the LD pin HIGH, the FIFO is returned to normal read/write operation. When the LD pin and WEN are again set LOW, the next offset register in sequence is written.

The contents of the offset registers can be read on the data output lines Q0-Q11 when the \overline{LD} pin is set LOW and \overline{REN} is set LOW. Data can then be read

on the next LOW-to-HIGH transition of RCLK. The first transition of RCLK will present the Empty Offset value to the data output lines. The next transition of RCLK will present the Full offset value. Offset register content can be read out in the IDT Standard mode only. It cannot be read in the FWFT mode.

SYNCHRONOUS vs ASYNCHRONOUS PROGRAMMABLE FLAG TIMING SELECTION

The IDT72805LB/72815LB/72825LB/72845LB can be configured during the "Configuration at Reset" cycle described in Table 3 with either asynchronous or synchronous timing for PAE and PAF flags.

If asynchronous PAE/PAF configuration is selected (as per Table 3), the PAE is asserted LOW on the LOW-to-HIGH transition of RCLK. PAE is reset to HIGH on the LOW-to-HIGH transition of WCLK. Similarly, the PAF is asserted LOW on the LOW-to-HIGH transition of WCLK and PAF is reset to HIGH on the LOW-to-HIGH transition of RCLK. For detail timing diagrams, see Figure 13 for asynchronous PAE timing and Figure 14 for asynchronous PAF timing.

If synchronous PAE/PAF configuration is selected, the PAE is asserted and updated on the rising edge of RCLK only and not WCLK. Similarly, PAF is asserted and updated on the rising edge of WCLK only and not RCLK. For detail timing diagrams, see Figure 22 for synchronous PAE timing and Figure 23 for synchronous PAF timing.

REGISTER-BUFFERED FLAG OUTPUT SELECTION

The IDT72805LB/72815LB/72825LB/72845LB can be configured during the "Configuration at Reset" cycle described in Table 4 with single, double or triple register-buffered flag output signals. The various combinations available are described in Table 4 and Table 5. In general, going from single to double or triple buffered flag outputs removes the possibility of metastable flag indications on boundary states (i.e, empty or full conditions). The trade-off is the addition of clock cycle delays for the respective flag to be asserted. Not all combinations of register-buffered flag outputs are supported. Register-buffered outputs apply to the Empty Flag and Full Flag only. Partial flags are not effected. Table 4 and Table 5 summarize the options available.

TABLE 1 — STATUS FLAGS FOR IDT STANDARD MODE

Number of Words in FIFO								
IDT72805LB	IDT72815LB	IDT72825LB	IDT72845LB	FF	PAF	ĦF	PAE	ĒĒ
0	0	0	0	Н	Н	Н	L	L
1 to n ⁽¹⁾	1 to n ⁽¹⁾	1 to n ⁽¹⁾	1 to n ⁽¹⁾	Н	Н	Н	L	Н
(n + 1) to 128	(n + 1) to 256	(n + 1) to 512	(n + 1) to 2,048	Н	Н	Н	Н	Н
129 to (256-(m+1)) ⁽²⁾	257 to (512-(m+1)) ⁽²⁾	513 to (1,024-(m+1)) ⁽²⁾	2,049 to (4,096-(m+1)) ⁽²⁾	Н	Н	L	Н	Н
(256-m) to 255	(512-m)to 511	(1,024-m) to 1,023	(4,096-m) to 4,095	Н	L	L	Н	Н
256	512	1,024	4,096	L	L	L	Н	Н

NOTES:

1. n = Empty offset (Default Values : IDT72805LB n=31, IDT72815LB n = 63, IDT72825LB/72845LB n = 127)

2. m = Full offset (Default Values : IDT72805LB m=31, IDT72815LB m = 63, IDT72825LB/72845LB m = 127)

TABLE 2 — STATUS FLAGS FOR FWFT MODE

IDT72805LB	IDT72815LB	IDT72825LB	IDT72845LB	ĪR	PAF	HF	PAE	ŌR
0	0	0	0	L	Н	Н	L	Н
1 to (n + 1) ⁽¹⁾	1 to (n + 1) ⁽¹⁾	1 to (n + 1) ⁽¹⁾	1 to (n + 1) ⁽¹⁾	L	Н	Н	L	L
(n + 2) to 129	(n + 2) to 257	(n + 2) to 513	(n + 2) to 2,049	L	Н	Н	Н	L
130 to (257-(m+1)) ⁽²⁾	258 to (513-(m+1)) ⁽²⁾	514 to (1,025-(m+1)) ⁽²⁾	2,050 to (4,097-(m+1)) ⁽²⁾	L	Н	L	Н	L
(257-m) to 256	(513-m) to 512	(1,025-m) to 1,024	(4,097-m) to 4,096	L	L	L	Н	L
257	513	1,025	4,097	Н	L	L	Н	L

NOTES:

1. n = Empty offset (Default Values : IDT72805LB n = 31, IDT72815LB n = 63, IDT72825LB/72845LB n = 127)

2. m = Full Offset (Default Values : IDT72805LB m = 31, IDT72815LB m = 63, IDT72825LB/72845LB m = 127)

FL	RXI	WXI	EF/OR	FF/IR	PAE, PAF	FIFO TIMING MODE	
0	0	0	Single register-buffered Empty Flag	Single register-buffered Full Flag	Asynchronous	Standard	
0	0	1	Triple register-buffered Output Ready Flag	Double register-buffered Input Ready Flag	Asynchronous	FWFT	
0	1	0	Double register-buffered Empty Flag	Double register-buffered Asynchronous Full Flag		Standard	
0(1)	1	1	Single register-buffered Empty Flag	Single register-buffered Full Flag	Asynchronous	Standard	
1	0	0	Single register-buffered Empty Flag	Single register-buffered Full Flag	Synchronous	Standard	
1	0	1	Triple register-buffered Output Ready Flag	Double register-buffered Input Ready Flag	Synchronous	FWFT	
1	1	0	Double register-buffered Empty Flag	Double register-buffered Full Flag	Synchronous	Standard	
1(2)	1	1	Single register-buffered Empty Flag	Single register-buffered Full Flag	Asynchronous	Standard	

NOTES:

1.

In a daisy-chain depth expansion, <u>FL</u> is held LOW for the "first load device". The <u>RXI</u> and <u>WXI</u> inputs are driven by the corresponding <u>RXO</u> and <u>WXO</u> outputs of the preceding device. In a daisy-chain depth expansion, <u>FL</u> is held HIGH for members of the expansion other than the "first load device". The <u>RXI</u> and <u>WXI</u> inputs are driven by the corresponding <u>RXO</u> and <u>WXO</u> outputs of the preceding <u>RXO</u> and <u>WXO</u> and <u>WXO</u> outputs of the preceding <u>RXO</u> and <u>WXO</u> and <u>WXO</u> outputs of the preceding <u>RXO</u> and <u>WXO</u> and <u>WXO</u> are driven by the corresponding <u>RXO</u> and <u>WXO</u> and <u>WXO</u> and <u>WXO</u> are driven by the corresponding <u>RXO</u> and <u>WXO</u> and <u>WXO</u> are driven by the corresponding <u>RXO</u> are driven by the cor 2.

TABLE 4 — REGISTER-BUFFERED FLAG OUTPUT OPTIONS — IDT STANDARD MODE

Empty Flag (EF) Buffered Output	Full Flag (FF) Buffered Output	Partial Flags Timing Mode	Programming at Reset FL RXI WXI		Flag Timing Diagrams	
Single	Single	Asynch	0	0	0	Figure 9, 10
Single	Single	Sync	1	0	0	Figure 9, 10
Double	Double	Asynch	0	1	0	Figure 24, 26
Double	Double	Synch	1	1	0	Figure 24, 26

TABLE 5 — REGISTER-BUFFERED FLAG OUTPUT OPTIONS — FWFT MODE

	Output Ready (OR)	Input Ready (IR)	Partial Flags	Progr FL	amming at RXI	Reset WXI	Flag Timing Diagrams
F	Triple	Double	Asynch	0	0	1	Figure 27
	Triple	Double	Sync	1	0	1	Figure 20, 21

COMMERCIAL AND INDUSTRIAL TEMPERATURE RANGES

SIGNAL DESCRIPTIONS:

INPUTS: DATA IN (D0 - D17)

Data inputs for 18-bit wide data.

CONTROLS: RESET (RSA/RSB)

Reset is accomplished whenever the Reset (RSA/RSB) input is taken to a LOW state. During reset, both internal read and write pointers are set to the first location. A reset is required after power-up before a write operation can take place. The Half-Full flag (HFA/HFB) and Programmable Almost-Full flag (PAFA/PAFB) will be reset to HIGH after tRSF. The Programmable Almost-Empty flag (PAEA/PAEB) will be reset to LOW after tRSF. The Full Flag (FFA/FFB) will reset to HIGH. The Empty Flag (EFA/EFB) will reset to LOW in IDT Standard mode but will reset to HIGH in FWFT mode. During reset, the output register is initialized to all zeros and the offset registers are initialized to their default values.

WRITE CLOCK (WCLKA/WCLKB)

A write cycle is initiated on the LOW-to-HIGH transition of the Write Clock (WCLKA/WCLKB). Data setup and hold times must be met with respect to the LOW-to-HIGH transition of WCLK.

The Write and Read Clocks can be asynchronous or coincident.

WRITE ENABLE (WENA/WENB)

When the WENA/WENB input is LOW, data may be loaded into the FIFO RAM array on the rising edge of every WCLK cycle if the device is not full. Data is stored in the RAM array sequentially and independently of any ongoing read operation.

When WEN is HIGH, no new data is written in the RAM array on each WCLK cycle.

To prevent data overflow in the IDT Standard Mode, \overline{FF} will go LOW, inhibiting further write operations. Upon the completion of a valid read cycle, \overline{FF} will go HIGH allowing a write to occur. The \overline{FF} flag is updated on the rising edge of WCLK.

To prevent data overflow in the FWFT mode, Input Ready (IRA, IRB) will go HIGH, inhibiting further write operations. Upon the completion of a valid read cycle, IR will go LOW allowing a write to occur. The IR flag is updated on the rising edge of WCLK.

WEN is ignored when the FIFO is full in either FWFT or IDT Standard mode.

READ CLOCK (RCLKA/RCLKB)

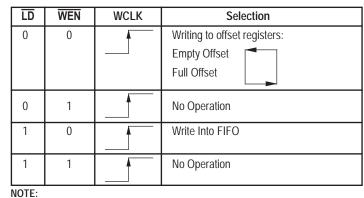
Data can be read on the outputs on the LOW-to-HIGH transition of the Read clock (RCLKA/RCLKB), when Output Enable (OEA/OEB) is set LOW. The Write and Read Clocks can be asynchronous or coincident.

READ ENABLE (RENA/RENB)

When Read Enable (RENA/RENB) is LOW, data is loaded from the RAM array into the output register on the rising edge of every RCLK cycle if the device is not empty.

When the REN input is HIGH, the output register holds the previous data and no new data is loaded into the output register. The data outputs Qo-Qn maintain the previous data value.

In the IDT Standard mode, every word accessed at Qn, including the first word written to an empty FIFO, must be requested using $\overline{\text{REN}}$. When the last word has been read from the FIFO, the Empty Flag ($\overline{\text{EFA}}/\overline{\text{EFB}}$) will go LOW, inhibiting further read operations. $\overline{\text{REN}}$ is ignored when the FIFO is



1. The same selection sequence applies to reading from the registers. REN is enabled and read is performed on the LOW-to-HIGH transition of RCLK.

Figure 2. Writing to Offset Registers



1. Any bits of the offset register not being programmed should be set to zero.

Figure 3. Offset Register Location and Default Values

empty. Once a write is performed, \overline{EF} will go HIGH allowing a read to occur. The \overline{EF} flag is updated on the rising edge of RCLK.

In the FWFT mode, the first word written to an empty FIFO automatically goes to the outputs Qn, on the third valid LOW to HIGH transition of RCLK + tskEw after the first write. REN does not need to be asserted LOW. In order to access all other words, a read must be executed using REN. The RCLK LOW to HIGH transition after the last word has been read from the FIFO, Output Ready (ORA/ORB) will go HIGH with a true read (RCLK with REN = LOW), inhibiting further read operations. REN is ignored when the FIFO is empty.

OUTPUT ENABLE (OEA/OEB)

When Output Enable ($\overline{OEA}/\overline{OEB}$) is enabled (LOW), the parallel output buffers receive data from the output register. When \overline{OE} is disabled (HIGH), the Q output data bus is in a high-impedance state.

LOAD (LDA/LDB)

The IDT72805LB/72815LB/72825LB/72845LB devices contain two 12-bit offset registers with data on the inputs, or read on the outputs. When the Load $(\overline{LDA}/\overline{LDB})$ pin is set LOW and \overline{WEN} is set LOW, data on the inputs D0-D11 is written into the Empty Offset register on the first LOW-to-HIGH transition of the Write clock (WCLK). When the \overline{LD} pin and \overline{WEN} are held LOW then data is written into the Full Offset register on the second LOW-to-HIGH transition of WCLK. The third transition of WCLK again writes to the Empty Offset register.

However, writing all offset registers does not have to occur at one time. One or two offset registers can be written and then by bringing the \overline{LD} pin HIGH, the FIFO is returned to normal read/write operation. When the \overline{LD} pin is set LOW, and \overline{WEN} is LOW, the next offset register in sequence is written.

When the LD pin is LOW and WEN is HIGH, the WCLK input is disabled; then a signal at this input can neither increment the write offset register pointer, nor execute a write.

The contents of the offset registers can be read on the output lines when the \overline{LD} pin is set LOW and \overline{REN} is set LOW; then, data can be read on the LOW-to-HIGH transition of the Read clock (RCLK). The act of reading the control registers employs a dedicated read offset register pointer. (The read and write pointers operate independently). Offset register content can be read out in the IDT Standard mode only. It is inhibited in the FWFT mode.

A read and a write should not be performed simultaneously to the offset registers.

FIRST LOAD (FLA/FLB)

For the single device mode, see Table I for additional information. In the Daisy Chain Depth Expansion configuration, FLA/FLB is grounded to indicate it is the first device loaded and is set to HIGH for all other devices in the Daisy Chain. (See Operating Configurations for further details.)

WRITE EXPANSION INPUT (WXIA/WXIB)

This is a dual purpose pin. For single device mode, see Table I for additional information. $\overline{WXIA}/\overline{WXIB}$ is connected to Write Expansion Out ($\overline{WXOA}/WXOB$) of the previous device in the Daisy Chain Depth Expansion mode.

READ EXPANSION INPUT (RXIA/RXIB)

This is a dual purpose pin. For single device mode, see Table I for additional information. RXIA/RXIB is connected to Read Expansion Out (RXOA/RXOB) of the previous device in the Daisy Chain Depth Expansion mode.

OUTPUTS:

FULL FLAG/INPUT READY (FFA/IRA, FFB/IRB)

This is a dual purpose pin. In IDT Standard mode, the Full Flag (\overline{FFA} / \overline{FFB}) function is selected. When the FIFO is full, \overline{FF} will go LOW, inhibiting further write operations. When \overline{FF} is HIGH, the FIFO is not full. If no reads are performed after a reset, \overline{FF} will go LOW after D writes to the FIFO. D = 256 writes for the IDT72805LB, 512 for the IDT72815LB, 1,024 for the IDT72825LB and 4,096 for the IDT72845LB.

In FWFT mode, the Input Ready ($\overline{IRA}/\overline{IRB}$) function is selected. \overline{IR} goes LOW when memory space is available for writing in data. When there is no longer any free space left, \overline{IR} goes HIGH, inhibiting further write operations.

 \overline{IR} will go HIGH after D writes to the FIFO. D = 257 writes for the IDT72805, 513 for the IDT72815, 1,025 for the IDT72825 and 4,097 for the IDT72845. Note that the additional word in FWFT mode is due to the capacity of the memory plus output register.

FF/IR is synchronous and updated on the rising edge of WCLK.

EMPTY FLAG/OUTPUT READY (EFA/ORA, EFB/ORB)

This is a dual purpose pin. In the IDT Standard mode, the Empty Flag $(\overline{EFA}/\overline{EFB})$ function is selected. When the FIFO is empty, \overline{EF} will go LOW, inhibiting further read operations. When \overline{EF} is HIGH, the FIFO is not empty.

In FWFT mode, the Output Ready ($\overline{ORA}/\overline{ORB}$) function is selected. \overline{OR} goes LOW at the same time that the first word written to an empty FIFO appears valid on the outputs. \overline{OR} stays LOW after the RCLK LOW to HIGH transition that shifts the last word from the FIFO memory to the outputs. \overline{OR} goes HIGH only with a true read (RCLK with $\overline{REN} = LOW$). The previous data stays at the outputs, indicating the last word was read. Further data reads are inhibited until \overline{OR} goes LOW again.

EF/OR is synchronous and updated on the rising edge of RCLK.

PROGRAMMABLE ALMOST-FULL FLAG (PAFA/PAFB)

The Programmable Almost-Full flag ($\overrightarrow{PAFA}/\overrightarrow{PAFB}$) will go LOW when FIFO reaches the almost-full condition. In IDT Standard mode, if no reads are performed after Reset (\overrightarrow{RS}), the \overrightarrow{PAF} will go LOW after (256-m) writes for the IDT72805LB, (512-m) writes for the IDT72815LB, (1,024-m) writes for the IDT72825LB and (4,096-m) writes for the IDT72845LB. The offset "m" is defined in the Full Offset register.

In FWFT mode, if no reads are performed, PAF will go LOW after (257m) writes for the IDT72805LB, (513-m) writes for the IDT72815LB, (1,025m) writes for the IDT72825LB and (4,097-m) writes for the IDT72845LB. The default values for m are noted in Table 1 and 2.

If asynchronous PAF configuration is selected, the PAF is asserted LOW on the LOW-to-HIGH transition of the Write Clock (WCLK). PAF is reset to HIGH on the LOW-to-HIGH transition of the Read Clock (RCLK). If synchronous PAF configuration is selected (see Table I), the PAF is updated on the rising edge of WCLK.

PROGRAMMABLE ALMOST-EMPTY FLAG (PAEA/PAEB)

The \overrightarrow{PAE} flag will go LOW when the FIFO reads the almost-empty condition. In IDT Standard mode, \overrightarrow{PAE} will go LOW when there are n words or less in the FIFO. In FWFT mode, the \overrightarrow{PAE} will go LOW when there are n+1 words or less in the FIFO. The offset "n" is defined as the Empty offset. The default values for n are noted in Table 1 and 2.

If asynchronous \overrightarrow{PAE} configuration is selected, the \overrightarrow{PAE} is asserted LOW on the LOW-to-HIGH transition of the Read Clock (RCLK). \overrightarrow{PAE} is reset to HIGH on the LOW-to-HIGH transition of the Write Clock (WCLK). If synchronous \overrightarrow{PAE} configuration is selected (see Table I), the \overrightarrow{PAE} is updated on the rising edge of RCLK.

WRITE EXPANSION OUT/HALF-FULL FLAG (WXOA/HFA, WXOB/HFB)

This is a dual-purpose output. In the Single Device and Width Expansion mode, when Write Expansion In (WXIA/WXIB) and/or Read Expansion In (RXIA/RXIB) are grounded, this output acts as an indication of a half-full memory.

After half of the memory is filled, and at the LOW-to-HIGH transition of the next write cycle, the Half-Full flag goes LOW and will remain set until the difference between the write pointer and read pointer is less than or equal to one half of the total memory of the device. The Half-Full flag (HFA/HFB) is then reset to HIGH by the LOW-to-HIGH transition of the Read Clock (RCLK). The HF is asynchronous.

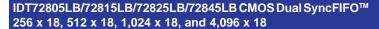
In the Daisy Chain Depth Expansion mode, WXI is connected to WXO of the previous device. This output acts as a signal to the next device in the Daisy Chain by providing a pulse when the previous device writes to the last location of memory.

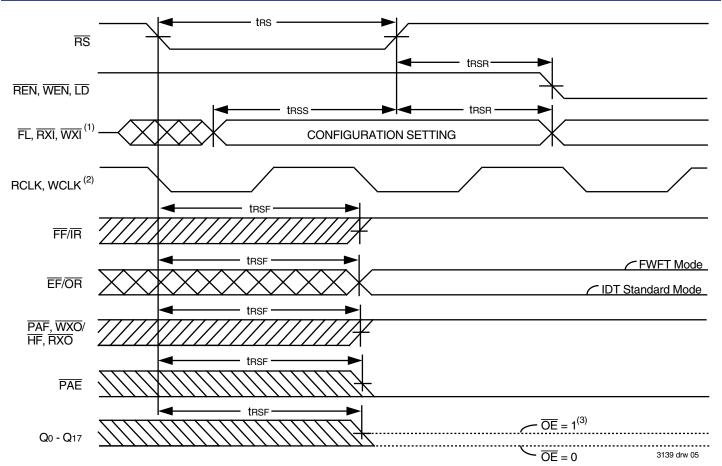
READ EXPANSION OUT (RXOA/RXOB)

In the Daisy Chain Depth Expansion configuration, Read Expansion In (RXIA/RXIB) is connected to Read Expansion Out (RXOA/RXOB) of the previous device. This output acts as a signal to the next device in the Daisy Chain by providing a pulse when the previous device reads from the last location of memory.

DATA OUTPUTS (Q0-Q17, QB0-QB17)

Q0-Q17 are data outputs for 18-bit wide data.

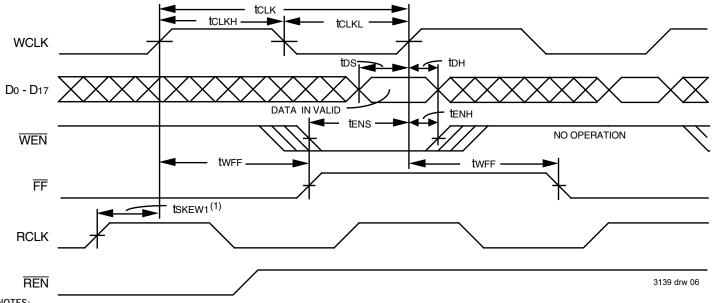




NOTES:

- 1. Single device mode (FL, RXI, WXI) = (0,0,0), (0,0,1), (0,1,0), (1,0,0), (1,0,1) or (1,1,0). FL, RXI, WXI should be static (tied to Vcc or GND).
- 2. The clocks (RCLK, WCLK) can be free-running asynchronously or coincidentally. 3. After reset, the outputs will be LOW if $\overline{OE} = 0$ and tri-state if $\overline{OE} = 1$.

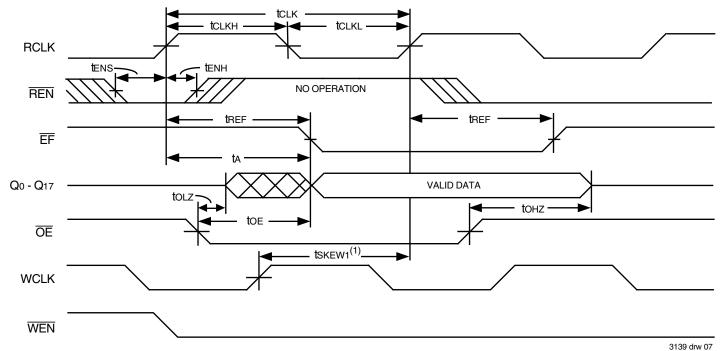
Figure 5. Reset Timing⁽²⁾



NOTES:

- tskew1 is the minimum time between a rising RCLK edge and a rising WCLK edge to guarantee that FF will go HIGH during the current clock cycle. If the time between the rising edge 1. of RCLK and the rising edge of WCLK is less than tskew1, then FF may not change state until the next WCLK edge.
- Select this mode by setting $(\overline{FL}, \overline{RXI}, \overline{WXI}) = (0,0,0), (0,1,1), (1,0,0)$ or (1,1,1) during Reset. 2.

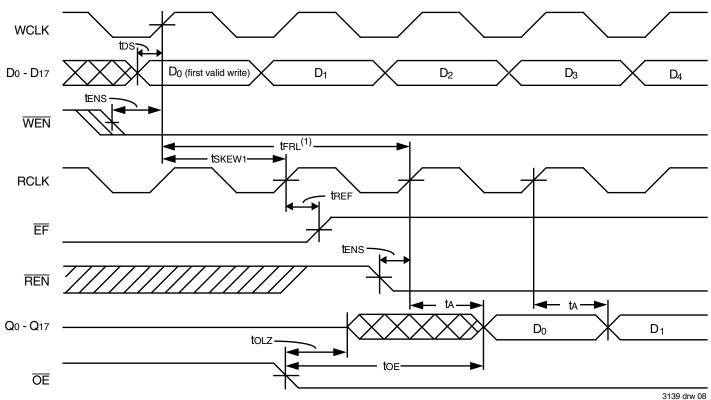
Figure 6. Write Cycle Timing with Single Register-Buffered FF (IDT Standard Mode)



NOTES:

- tskewi is the minimum time between a rising WCLK edge and a rising RCLK edge to guarantee that EF will go HIGH during the current clock cycle. If the time between the rising edge of WCLK and the rising edge of RCLK is less than tskewi, then EF may not change state until the next RCLK edge.
- 2. Select this mode by setting $(\overline{FL}, \overline{RXI}, \overline{WXI}) = (0,0,0), (0,1,1), (1,0,0)$ or (1,1,1) during Reset.

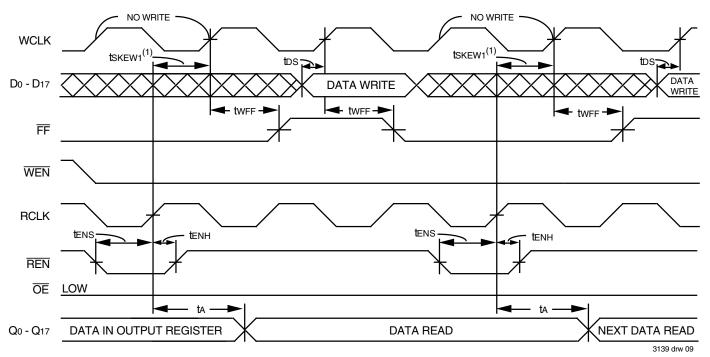
Figure 7. Read Cycle Timing with Single Register-Buffered EF (IDT Standard Mode)



NOTES:

- When tskew1 minimum specification, tFRL (maximum) = tcLK + tskew1. When tskew1 < minimum specification, tFRL (maximum) = either 2*tcLK + tskew1 or tcLK + tskew1. The Latency Timing applies only at the Empty Boundary (EF = LOW).
- 2. The first word is available the cycle after EF goes HIGH, always.
- 3. Select this mode by setting (FL, RXI, WXI) = (0,0,0), (0,1,1), (1,0,0) or (1,1,1) during Reset.

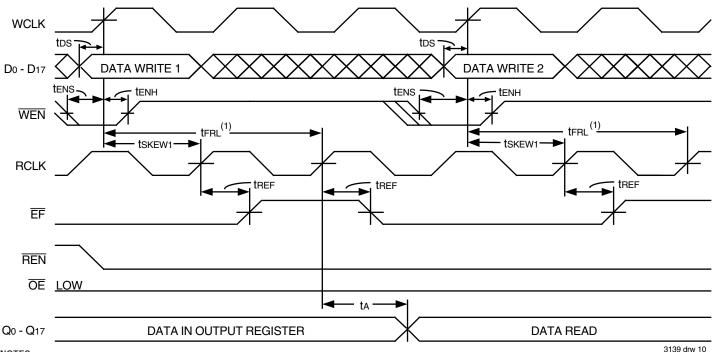
Figure 8. First Data Word Latency with Single Register-Buffered EF (IDT Standard Mode)



NOTES:

- tskewi is the minimum time between a rising RCLK edge and a rising WCLK edge to guarantee that FF will go HIGH during the current clock cycle. If the time between the rising edge of RCLK and the rising edge of WCLK is less than tskewi, then FF may not change state until the next WCLK edge.
- 2. Select this mode by setting (FL, RXI, WXI) = (0,0,0), (0,1,1), (1,0,0) or (1,1,1) during Reset.

Figure 9. Single Register-Buffered Full Flag Timing (IDT Standard Mode)



NOTES:

1. When tskew1 minimum specification, tFRL (maximum) = tcLK + tskew1. When tskew1 < minimum specification, tFRL (maximum) = either 2 * tcLK + tskew1. or tcLK + tskew1. The Latency Timing apply only at the Empty Boundary (EF = LOW).

2. Select this mode by setting (FL, RXI, WXI) = (0,0,0), (0,1,1), (1,0,0) or (1,1,1) during Reset.

Figure 10. Single Register-Buffered Empty Flag Timing (IDT Standard Mode)

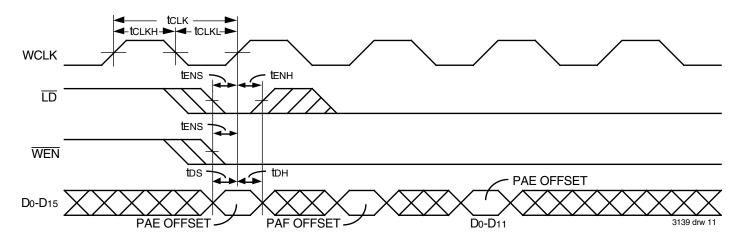


Figure 11. Write Programmable Registers (IDT Standard and FWFT Modes)

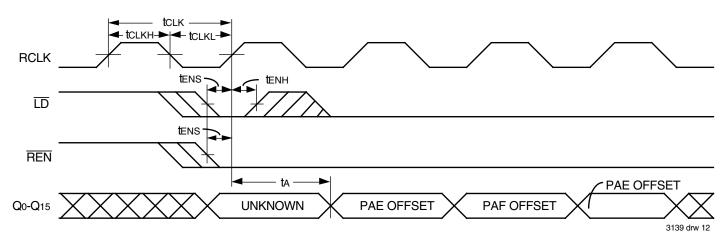
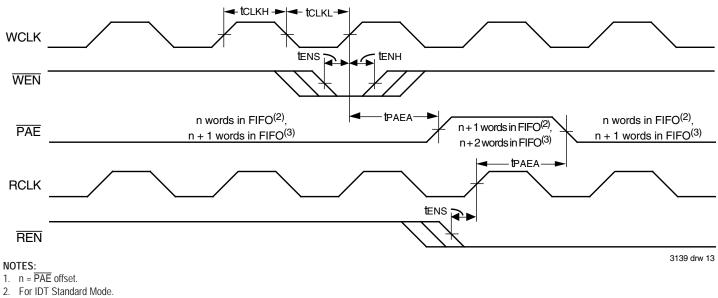


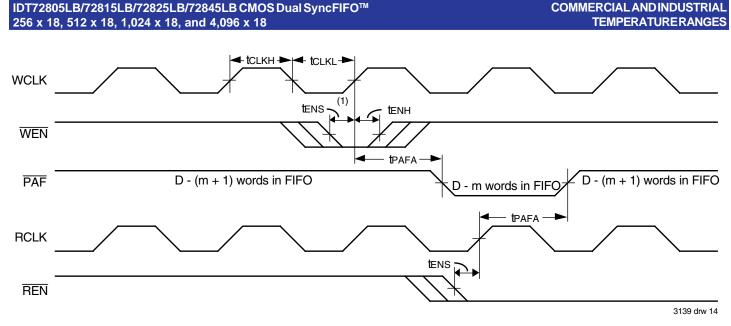
Figure 12. Read Programmable Registers (IDT Standard Mode)



3. For FWFT Mode.

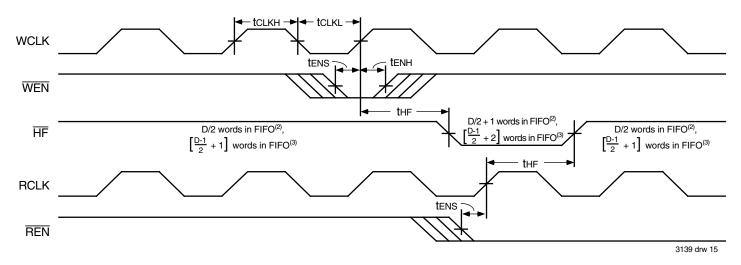
- 4. **PAE** is asserted LOW on RCLK transition and reset to HIGH on WCLK transition.
- 5. Select this mode by setting (FL, RXI, WXI) = (0,0,0), (0,0,1), (0,1,0), (0,1,1) or (1,1,1) during Reset.

Figure 13. Asynchronous Programmable Almost-Empty Flag Timing (IDT Standard and FWFT Modes)



NOTES:

- 1. $m = \overline{PAF}$ offset.
- 2. D = maximum FIFO Depth.
- In IDT Standard Mode: D = 256 for the IDT72805, 512 for the IDT72815, 1,024 for the IDT72825 and 4,096 for the IDT72845.
- In FWFT Mode: D = 257 for the IDT72805, 513 for the IDT72815, 1,025 for the IDT72825 and 4,097 for the IDT72845.
- 3. PAF is asserted to LOW on WCLK transition and reset to HIGH on RCLK transition.
- 4. Select this mode by setting $(\overline{FL}, \overline{RXI}, \overline{WXI}) = (0,0,0), (0,0,1), (0,1,0), (0,1,1) \text{ or } (1,1,1) \text{ during Reset.}$



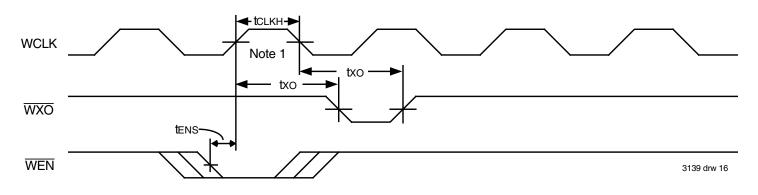
NOTES:

- 1. D = maximum FIFO Depth.
 - In IDT Standard Mode: D = 256 for the IDT72805, 512 for the IDT72815, 1,024 for the IDT72825 and 4,096 for the IDT72845.
- In FWFT Mode: D = 257 for the IDT72805, 513 for the IDT72815, 1,025 for the IDT72825 and 4,097 for the IDT72845.
- 2. For IDT Standard Mode.
- 3. For FWFT Mode.
- 4. Select this mode by setting (FL, RXI, WXI) = (0,0,0), (0,0,1), (0,1,0), (1,0,0), (1,0,1) or (1,1,0) during Reset.

Figure 15. Half-Full Flag Timing (IDT Standard and FWFT Modes)

Figure 14. Asynchronous Programmable Almost-Full Flag Timing (IDT Standard and FWFT Modes)

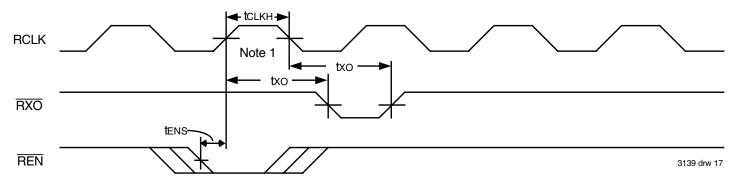
COMMERCIAL AND INDUSTRIAL TEMPERATURE RANGES



NOTE:

1. Write to Last Physical Location.

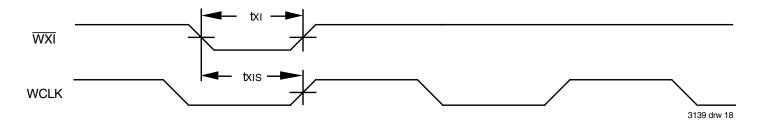




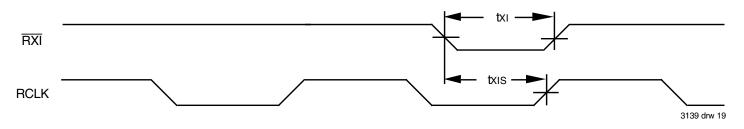
NOTE:

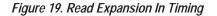
1. Read from Last Physical Location.

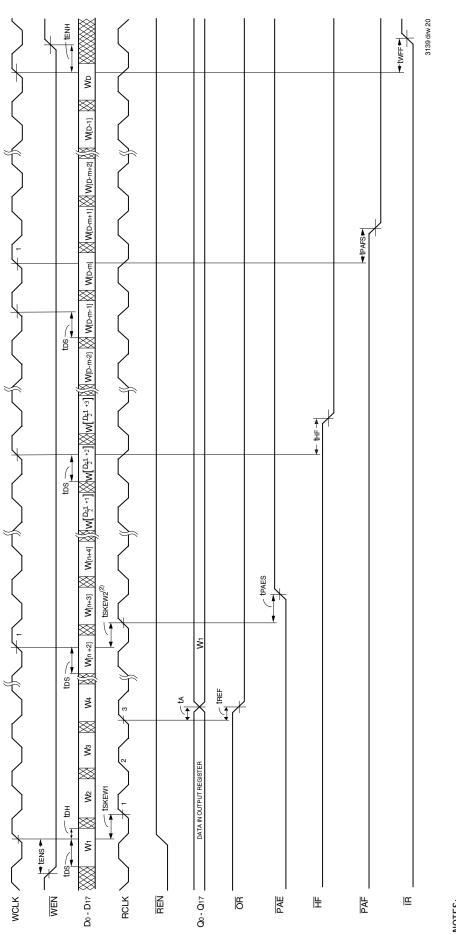










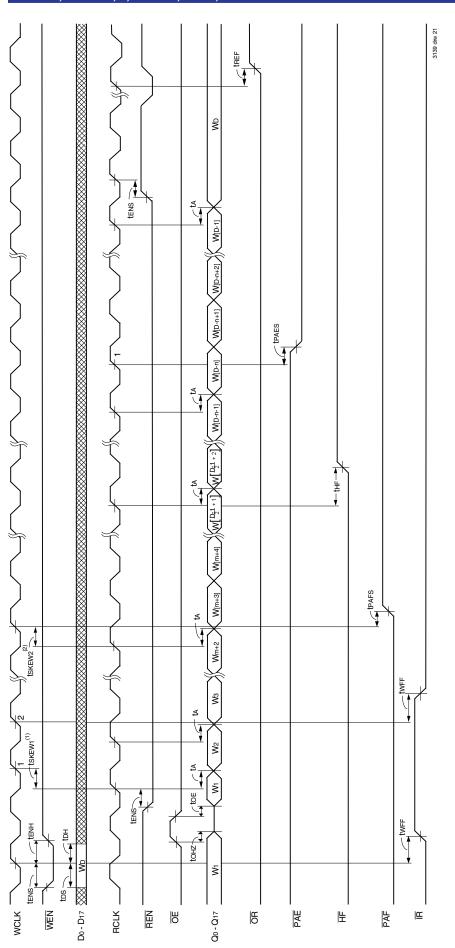


NOTES:

18

- The time between the rising work and a rising RCLK edge for <u>OR</u> to go LOW after two RCLK cycles plus tref. If the time between the rising edge of WLCK and the rising edge of RCLK is less than tskewi, then the <u>OR</u> deassertion may be delayed one extra RCLK cycle. <u>.</u> ц.
 - PAE deassertion may be delayed one extra RCLK cycle.
 - 5. 4 ..
 - $\overrightarrow{\text{LD}}$ = HiGH, $\overrightarrow{\text{OE}}$ = LOW n = $\overrightarrow{\text{PAE}}$ offset, m = $\overrightarrow{\text{PAF}}$ offset, D = maximum FIFO depth = 257 words for the IDT72805, 513 words for the IDT72815, 1,025 words for the IDT72825 and 4,097 words for the IDT72845. Select this mode by setting ($\overrightarrow{\text{FL}}$, $\overrightarrow{\text{RM}}$, $\overrightarrow{\text{WX}}$) = (1,0,1) during Reset.

Figure 20. Write Timing with Synchronous Programmable Flags (FWFT Mode)



NOTES:

19

- 1. txew is the minimum time between a rising RCLK edge and a rising WCLK edge to guarantee that IR will go LOW after one WCLK plus twer. If the time between the rising edge of RLCK and the rising edge of WCLK is less than txem, then the IR assertion may be delayed an extra WCLK cycle.
- txexus is the minimum time between a rising RCLK edge and a rising WCLK edge for PAF to go HIGH during the current clock cycle. If the time between the rising edge of RCLK and the rising edge of WCLK is less than tskews, then the PAF deassertion time may be delayed an extra WCLK cycle. $\overline{LD} = HIGH$
 - ć.

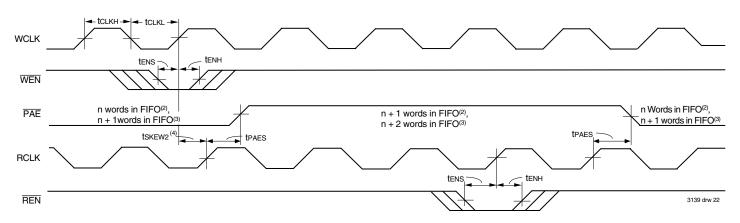
ц Сі

- n = \overline{PAE} offset, m = \overline{PAF} offset, D = maximum FIFO depth = 257 words for the IDT72805, 513 words for the IDT72815, 1,025 words for the IDT72825 and 4,097 words for IDT72845. Select this mode by setting (\overline{FL} , \overline{RX} , \overline{WXI}) = (1,0,1) during Reset. 5.4

Figure 21. Read Timing with Synchronous Programmable Flags (FWFT Mode)

COMMERCIAL AND INDUSTRIAL

TEMPERATURE RANGES



NOTES:

1. $n = \overline{PAE}$ offset.

2. For IDT Standard Mode.

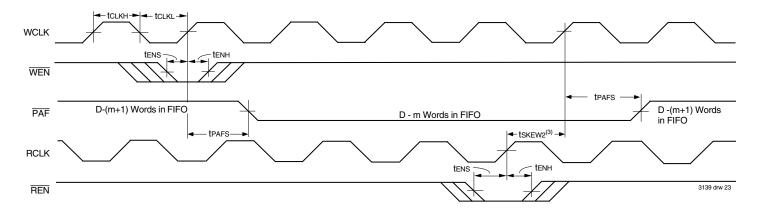
3. For FWFT Mode.

4. tskEw2 is the minimum time between a rising WCLK edge and a rising RCLK edge for PAE to go HIGH during the current clock cycle. If the time between the rising edge of WCLK and the rising edge of RCLK is less than tskEw2, then the PAE deassertion may be delayed one extra RCLK cycle.

5. PAE is asserted and updated on the rising edge of RCLK only.

6. Select this mode by setting $(\overline{FL}, \overline{RXI}, \overline{WXI}) = (1,0,0), (1,0,1), \text{ or } (1,1,0)$ during Reset.

Figure 22. Synchronous Programmable Almost-Empty Flag Timing (IDT Standard and FWFT Modes)



NOTES:

1. m = PAF offset.

2. D = maximum FIFO Depth.

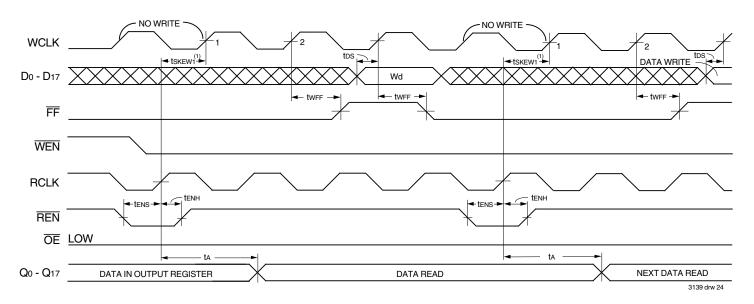
In IDT Standard Mode: D = 256 for the IDT72805, 512 for the IDT72815, 1,024 for the IDT72825 and 4,096 for the IDT72845.

In FWFT Mode: D = 257 for the IDT72805, 513 for the IDT72815, 1,025 for the IDT72825 and 4,097 for the IDT72845.

- 3. tskew2 is the minimum time between a rising RCLK edge and a rising WCLK edge for PAF to go HIGH during the current clock cycle. If the time between the rising edge of RCLK and the rising edge of WCLK is less than tskew2, then the PAF deassertion time may be delayed an extra WCLK cycle.
- 4. **PAF** is asserted and updated on the rising edge of WCLK only.
- 5. Select this mode by setting $(\overline{FL}, \overline{RXI}, \overline{WXI}) = (1,0,0), (1,0,1), \text{ or } (1,1,0) \text{ during Reset.}$

Figure 23. Synchronous Programmable Almost-Full Flag Timing (IDT Standard and FWFT Modes)

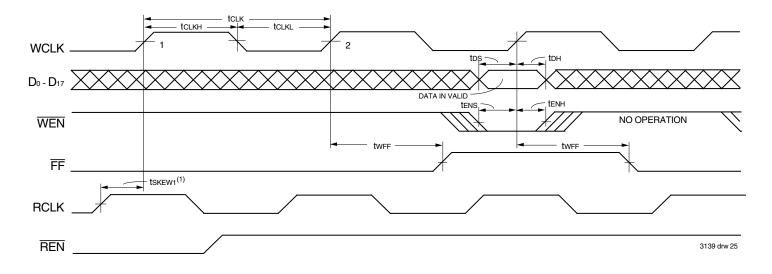
COMMERCIAL AND INDUSTRIAL TEMPERATURE RANGES



NOTES:

- 1. tskewi is the minimum time between a rising RCLK edge and a rising WCLK edge to guarantee that FF will go HIGH after one WCLK cycle plus twFF. If the time between the rising edge of RCLK and the rising edge of WCLK is less than tskewi, then the FF deassertion time may be delayed an extra WCLK cycle.
- 2. $\overline{LD} = HIGH$.
- 3. Select this mode by setting (FL, RXI, WXI) = (0,1,0) or (1,1,0) during Reset.

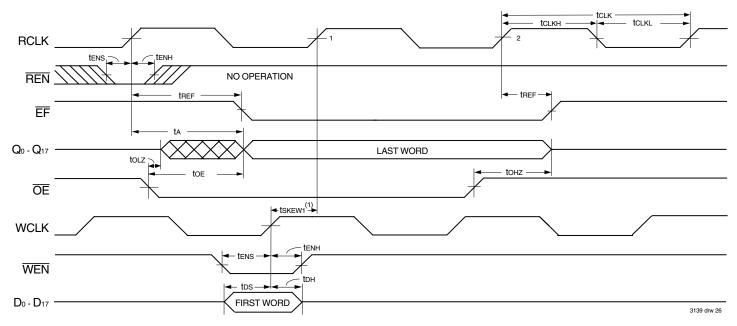
Figure 24. Double Register-Buffered Full Flag Timing (IDT Standard Mode)



NOTES:

- tskEW1 is the minimum time between a rising RCLK edge and a rising WCLK edge to guarantee that FF will go HIGH after one WCLK cycle plus tRFF. If the time between the rising edge of RCLK and the rising edge of WCLK is less than tskEW1, then the FF deassertion may be delayed an extra WCLK cycle.
- 2. $\overline{LD} = HIGH$.
- 3. Select this mode by setting $(\overline{FL}, \overline{RXI}, \overline{WXI}) = (0,1,0)$ or (1,1,0) during Reset.

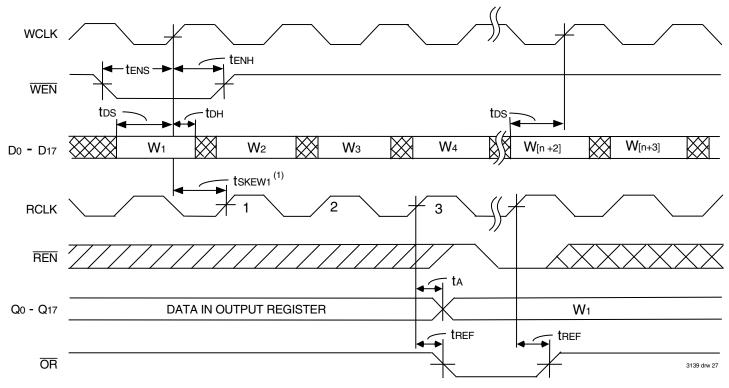
Figure 25. Write Cycle Timing with Double Register-Buffered FF (IDT Standard Mode)



NOTES:

- tskEwn is the minimum time between a rising WCLK edge and a rising RCLK edge to guarantee that EF will go HIGH after one RCLK cycle plus tREF. If the time between the rising edge of WCLK and the rising edge of RCLK is less than tskEwn. then the EF deassertion may be delayed an extra RCLK cycle.
 LD = HIGH
- 3. Select this mode by setting (\overline{FL} , \overline{RXI} , \overline{WXI}) = (0,1,0) or (1,1,0) during Reset.

Figure 26. Read Cycle Timing with Double Register-Buffered EF (IDT Standard Timing)



NOTES:

- tskewi is the minimum time between a rising WCLK edge and a rising RCLK edge for OR to go HIGH during the current cycle. If the time between the rising edge of WLCK and the rising edge of RCLK is less than tskewi, then the OR deassertion may be delayed one extra RCLK cycle.
- 2. $\overline{LD} = HIGH, \overline{OE} = LOW$
- 3. Select this mode by setting (\overline{FL} , \overline{RXI} , \overline{WXI}) = (0,0,1) or (1,0,1) during Reset.

Figure 27. **OR** *Flag Timing and First Word Fall Through when FIFO is Empty (FWFT mode)*

COMMERCIAL AND INDUSTRIAL TEMPERATURE RANGES

OPERATING CONFIGURATIONS

SINGLE DEVICE CONFIGURATION

Each of the two FIFOs contained in a single IDT72805LB/72815LB/ 72825LB/72845LB may be used as a stand-alone device when the application requirements are for 256/512/1,024/4,096 words or less. These FIFOs are in a single Device Configuration when the First Load (\overline{FL}), Write Expansion In (\overline{WXI}) and Read Expansion In (\overline{RXI}) control inputs are configured as (\overline{FL} , \overline{RXI} , $\overline{WXI} = (0,0,0)$, (0,0,1), (0,1,0), (1,0,0), (1,0,1) or (1,1,0) during reset (Figure 28).

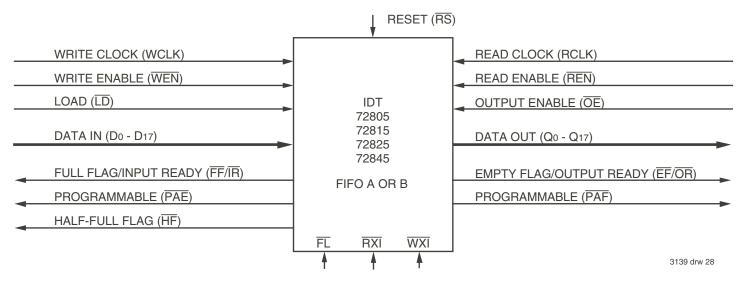
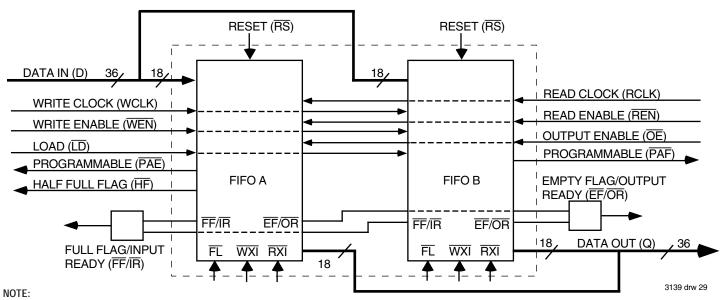


Figure 28. Block Diagram of Single 256 x 18, 512 x 18, 1,024 x 18, 4,096 x 18 Synchronous FIFO (One of the two FIFOs contained in the IDT72805LB/72815LB/72825LB/72845LB)

WIDTH EXPANSION CONFIGURATION

Word width may be increased simply by connecting together the control signals of FIFO A and B. Status flags can be detected from any one device. The exceptions are the Empty Flag/Output Ready and Full Flag/Input Ready. Because of variations in skew between RCLK and WCLK, it is possible for flag assertion and deassertion to vary by one cycle between FIFOs. To avoid problems the user must create composite flags by gating the Empty Flags/Output Ready of every FIFO, and separately gating all Full

Flags/Input Ready. Figure 29 demonstrates a 36-word width by using one IDT72805LB/72815LB/72825LB/72845LBs. Any word width can be attained by adding additional IDT72805LB/72815LB/72825LB/72845LBs. These FIFOs are in a single Device Configuration when the First Load (FL), Write Expansion In (WXI) and Read Expansion In (RXI) control inputs are configured as (FL, RXI, WXI = (0,0,0), (0,0,1), (0,1,0), (1,0,0), (1,0,1) or (1,1,0) during reset (Figure 29). Please see the Application Note AN-83.



1. Do not connect any output control signals directly together.

Figure 29. Block Diagram of the two FIFOs contained in one IDT72805LB/72815LB/72825LB/72845LB configured for a 36-bit Width Expansion

DEPTH EXPANSION CONFIGURATION — DAISY CHAIN TECHNIQUE (WITH PROGRAMMABLE FLAGS)

These devices can easily be adapted to applications requiring more than 256/512/1,024/4,096 words of buffering. Figure 30 shows Depth Expansion using one IDT72805LB/72815LB/72825LB/72845LBs. Maximum depth is limited only by signal loading. Follow these steps:

- $1. The first device must be designated by grounding the First Load (\overline{FL}) control input.$
- 2. All other devices must have \overline{FL} in the HIGH state.
- 3. The Write Expansion Out (WXO) pin of each device must be tied to the Write Expansion In (WXI) pin of the next device. See Figure 30.
- 4. The Read Expansion Out (RXO) pin of each device must be tied to the Read Expansion In (RXI) pin of the next device. See Figure 30.
- 5. All Load (LD) pins are tied together.
- 6. The Half-Full flag (HF) is not available in this Depth Expansion Configuration.
- 7. EF, FF, PAE, and PAF are created with composite flags by ORing together every respective flags for monitoring. The composite PAE and PAF flags are not precise.
- 8. In Daisy Chain mode, the flag outputs are single register-buffered and the partial flags are in asynchronous timing mode.

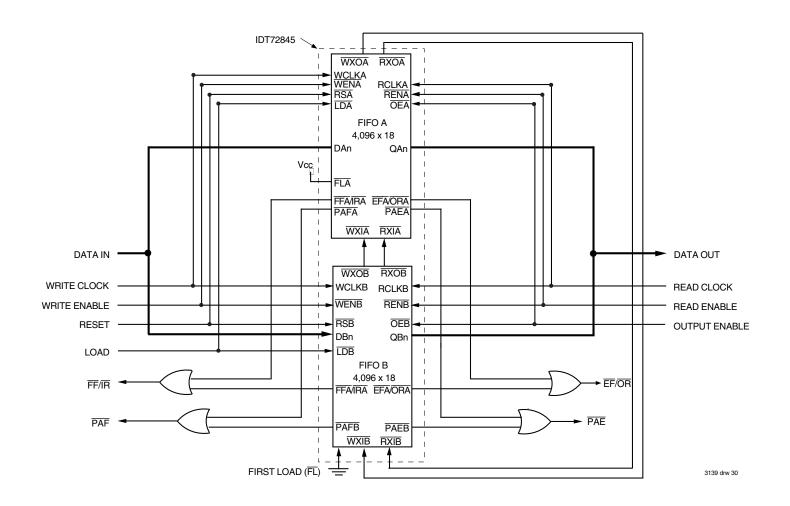


Figure 30. Block Diagram of 8,192 x 18 Synchronous FIFO Memory With Programmable Flags used in Depth Expansion Configuration

DEPTH EXPANSION CONFIGURATION (FWFT MODE)

In FWFT mode, the FIFOs can be connected in series (the data outputs of one FIFO connected to the data inputs of the next) with no external logic necessary. The resulting configuration provides a total depth equivalent to the sum of the depths associated with each single FIFO. Figure 31 shows a depth expansion using one IDT72805LB/72815LB/72825LB/72845LB devices.

Care should be taken to select FWFT mode during Master Reset for all FIFOs in the depth expansion configuration. The first word written to an empty configuration will pass from one FIFO to the next ("ripple down") until it finally appears at the outputs of the last FIFO in the chain–no read operation is necessary but the RCLK of each FIFO must be free-running. Each time the data word appears at the outputs of one FIFO, that device's OR line goes LOW, enabling a write to the next FIFO in line.

For an empty expansion configuration, the amount of time it takes for \overline{OR} of the last FIFO in the chain to go LOW (i.e. valid data to appear on the last FIFO's outputs) after a word has been written to the first FIFO is the sum of the delays for each individual FIFO:

(N – 1)*(4*transfer clock) + 3*TRCLK

where N is the number of FIFOs in the expansion and TRCLK is the RCLK period. Note that extra cycles should be added for the possibility that the

tskew1 specification is not met between WCLK and transfer clock, or RCLK and transfer clock, for the \overline{OR} flag.

The "ripple down" delay is only noticeable for the first word written to an empty depth expansion configuration. There will be no delay evident for subsequent words written to the configuration.

The first free location created by reading from a full depth expansion configuration will "bubble up" from the last FIFO to the previous one until it finally moves into the first FIFO of the chain. Each time a free location is created in one FIFO of the chain, that FIFO's \overline{IR} line goes LOW, enabling the preceding FIFO to write a word to fill it.

For a full expansion configuration, the amount of time it takes for \overline{IR} of the first FIFO in the chain to go LOW after a word has been read from the last FIFO is the sum of the delays for each individual FIFO:

(N – 1)*(3*transfer clock) + 2 TWCLK

where N is the number of FIFOs in the expansion and TWCLK is the WCLK period. Note that extra cycles should be added for the possibility that the tsKEW1 specification is not met between RCLK and transfer clock, or WCLK and transfer clock, for the \overline{IR} flag.

The Transfer Clock line should be tied to either WCLK or RCLK, whichever is faster. Both these actions result in data moving, as quickly as possible, to the end of the chain and free locations to the beginning of the chain.

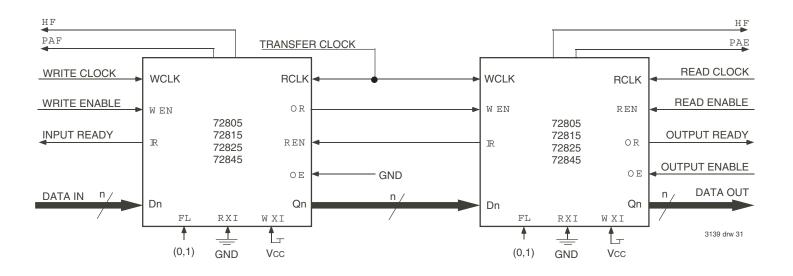
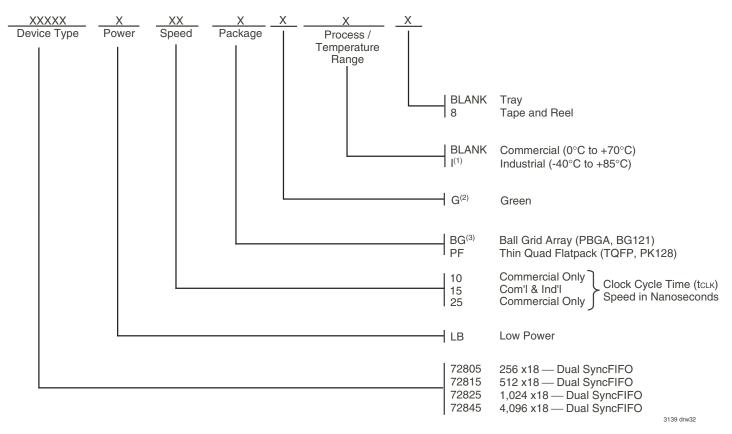


Figure 31. Block Diagram of 512 x 18, 1,024 x 18, 2,048 x 18, 8,192 x 18 Synchronous FIFO Memory With Programmable Flags used in Depth Expansion Configuration

ORDERING INFORMATION



NOTES:

- 1. Industrial temperature range product for the 15ns speed grade is available as a standard device.
- 2. Green parts are available. For specific speeds and packages contact your sales office.
- LEAD FINISH (SnPb) parts are in EOL process. Product Discontinuation Notice PDN# SP-17-02
- 3. The PBGA is only available for the IDT72805LB/72815LB/72825LB in the 15 or 25 ns speed grade.

DATASHEET DOCUMENT HISTORY

05/01/2001 pgs. 1, 5, 6, and 26.			
02/12/2003 pgs. 1, 2, and 26.			
11/30/2004 pg. 5.			
02/22/2006 pgs. 1 and 26.			
01/13/2009 pg. 26.			
05/23/2016 pgs. 1-26.			
03/19/2018 Product Discontinuation Notice - PDN# SP-17-0	Product Discontinuation Notice - PDN# SP-17-02		
Last time buy expires June 15, 2018.			

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